

聯華電子 112年第一季財務報告

112年4月26日

NOTE CONCERNING FORWARD-LOOKING STATEMENTS

This presentation contains forward-looking statements within the meaning of Section 27A of the United States Securities Act of 1933, as amended, and Section 21E of the United States Securities Exchange Act of 1934, as amended, and as defined in the United States Private Securities Litigation Reform Act of 1995. These forward looking statements include, but are not limited to, statements relating to anticipated quarterly Fab capacity, foundry capital expenditure plan and other statements that are not historical information.

These forward-looking statements involve known and unknown risks, uncertainties and other factors that may cause the actual performance, financial condition or results of operations of UMC to be materially different from what is stated or may be implied in such forward-looking statements. Investors are cautioned that actual events and results could differ materially from those statements as a result of a number of factors including, but not limited to: (i) dependence upon the frequent introduction of new services and technologies based on the latest developments in the industry in which UMC operates; (ii) the intensely competitive semiconductor, communications, consumer electronics and computer industries and markets; (iii) the risks associated with international business activities; (iv) dependence upon key personnel; (v) general economic, political and industry conditions, including any geopolitical conflict between U.S., China and Taiwan (vi) possible disruptions in commercial activities caused by natural and human-induced events and disasters, including natural disasters, terrorist activity, armed conflict, highly contagious diseases, and pandemics, such as the ongoing Russia-Ukraine conflict; (vii) reduced end-user purchases relative to expectations and orders; (viii) regulatory development and legal proceedings, including ongoing litigation, (ix) fluctuations in foreign currency exchange rates and (x) disruption in global supply chain affecting the semiconductor industry. Further information regarding these and other risks is included in UMC's filings with the United States Securities and Exchange Commission, including UMC's Annual Report on Form 20-F for the fiscal year ended December 31, 2021. All information provided in this release is as of the date of this release and are based on assumptions that UMC believes to be reasonable as of this date, and UMC does not undertake any obligation to update any forward-looking statement as a result of new information, future events or otherwise, except as required under applicable law.

The financial statements included in this release are prepared and published in accordance with Taiwan International Financial Reporting Standards, or TIFRSs, recognized by the Financial Supervisory Commission in the ROC, which is different from International Financial Reporting Standards, or IFRSs, issued by the International Accounting Standards Board. Investors are cautioned that there may be significant differences between TIFRSs and IFRSs. In addition, TIFRSs and IFRSs differ in certain significant respects from generally accepted accounting principles in the ROC and generally accepted accounting principles in the United States.

This presentation is not an offer of securities for sale in the United States. Securities may not be offered or sold in the United States absent registration or an exemption from registration under the Securities Act of 1933, as amended. Any public offering of securities to be made in the United States will be made by means of a prospectus that may be obtained from the issuer at the time of such offering that will contain detailed information about the company and management, as well as financial statements.

營運結果摘要

單位: 新台幣 百萬元

	112年 第一季/3月	111年 第四季/12月	111年 第一季/3月
營業收入	54,209	67,836	63,423
歸屬母公司淨利	16,183	19,068	19,808
普通股每股盈餘 (元)	1.31	1.54	1.61
現金及約當現金	171,834	173,819	172,170
總資產	549,631	533,052	482,909
總負債	194,081	197,601	180,624
總權益	355,550	335,451	302,285
晶圓製造整合：			
出貨片數 (仟片-約當8吋片數)	1,826	2,213	2,513
產能利用率 (%)	70%	90%	100%+

綜合損益表 – 112年第一季 vs.111年第四季

單位: 新台幣 百萬元

	112年 第一季	%	111年 第四季	%	差異 %
營業收入	54,209	100.0	67,836	100.0	(20.1)
營業毛利	19,224	35.5	29,124	42.9	(34.0)
營業費用	(5,780)	(10.7)	(6,798)	(10.0)	(15.0)
其他收益及費損淨額	1,037	1.9	1,311	1.9	(20.9)
營業利益	14,481	26.7	23,637	34.8	(38.7)
營業外收入及支出	4,647	8.6	889	1.4	422.6
所得稅費用	(2,743)	(5.1)	(5,406)	(8.0)	(49.2)
本期淨利	16,385	30.2	19,120	28.2	(14.3)
歸屬母公司淨利	16,183	29.9	19,068	28.1	(15.1)
普通股每股盈餘 (元)	1.31		1.54		

註: 112年第一季及111年第四季加權平均流通在外普通股股數均為12,349百萬股。

綜合損益表 – 112年及111年1月1日至3月31日

單位: 新台幣 百萬元

	112年 1~3月	%	111年 1~3月	%	差異 %
營業收入	54,209	100.0	63,423	100.0	(14.5)
營業毛利	19,224	35.5	27,504	43.4	(30.1)
營業費用	(5,780)	(10.7)	(6,513)	(10.3)	(11.3)
其他收益及費損淨額	1,037	1.9	1,343	2.1	(22.8)
營業利益	14,481	26.7	22,334	35.2	(35.2)
營業外收入及支出	4,647	8.6	1,314	2.1	253.8
所得稅費用	(2,743)	(5.1)	(3,582)	(5.7)	(23.4)
本期淨利	16,385	30.2	20,066	31.6	(18.3)
歸屬母公司淨利	16,183	29.9	19,808	31.2	(18.3)
普通股每股盈餘 (元)	1.31		1.61		

註: 112年第一季及111年第一季加權平均流通在外普通股股數分別為12,349百萬股及12,283百萬股。

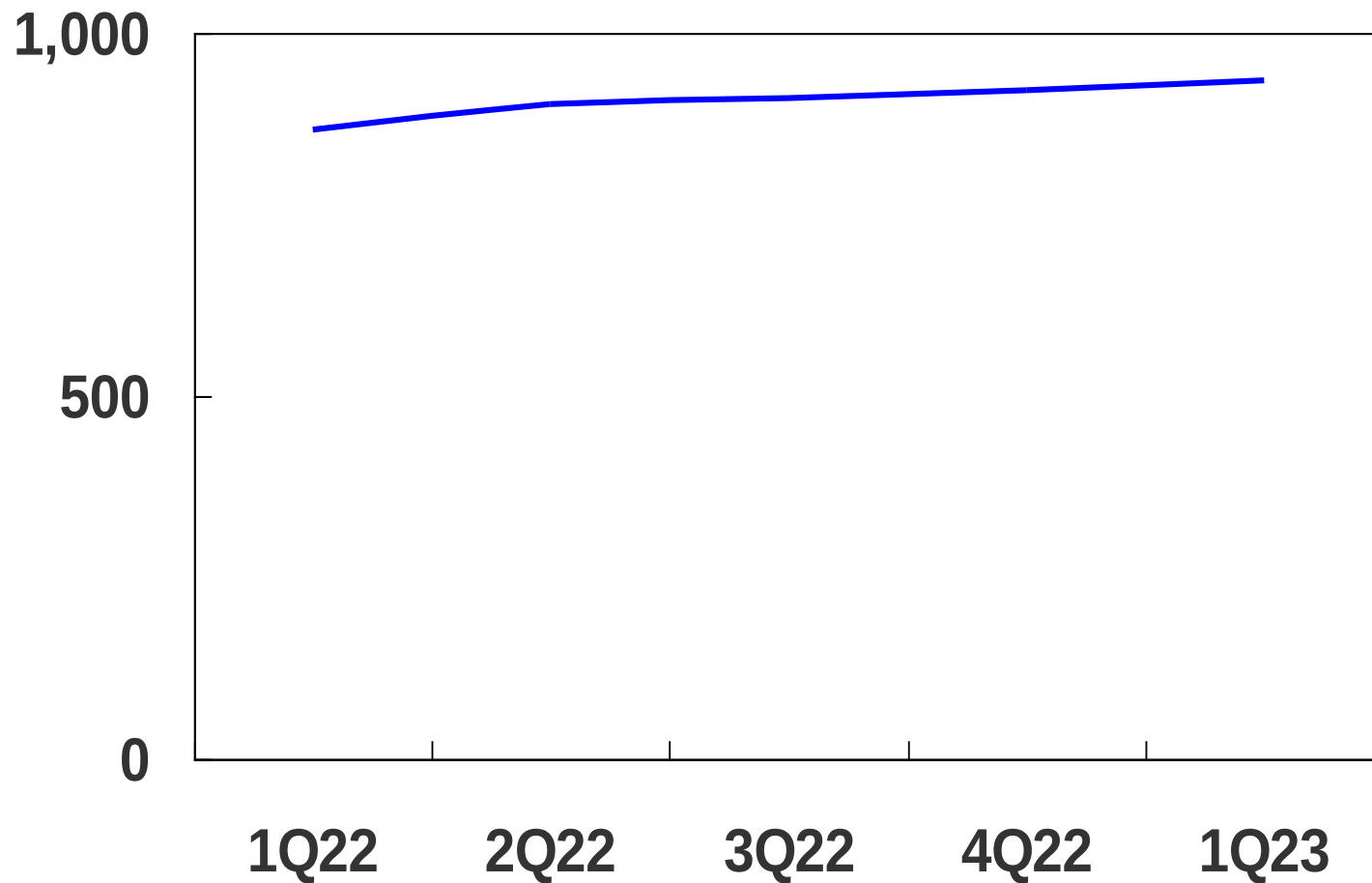
簡要資產負債表 – 112年3月31日

單位: 新台幣 百萬元

現金及約當現金	171,834
基金及投資	72,087
不動產、廠房及設備	192,185
總資產	549,631
流動負債	105,886
長期借款/公司債	37,303
總權益	355,550

晶圓製造整合平均售價趨勢圖

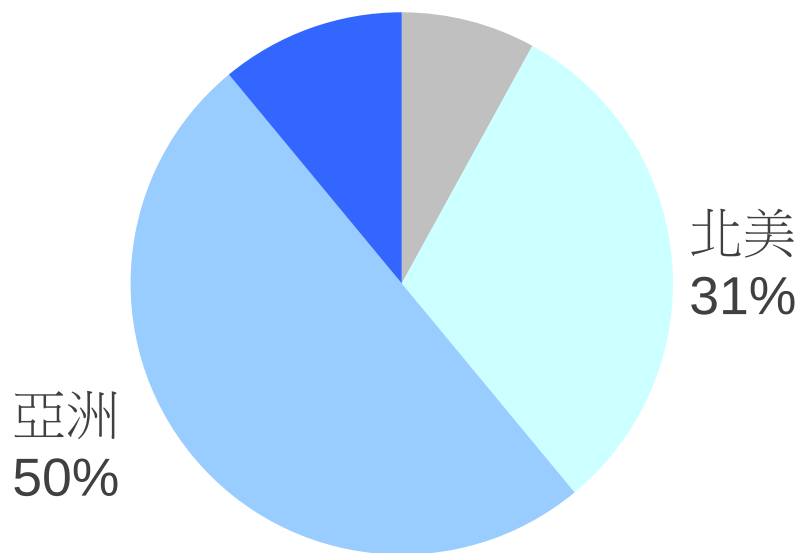
Unit: USD



晶圓製造整合銷售分析－地區別

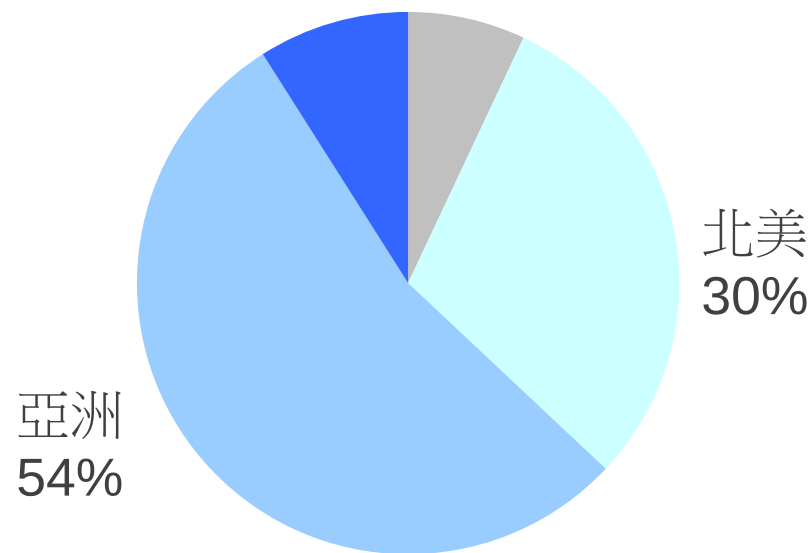
1Q23

歐洲 11% 日本 8%



4Q22

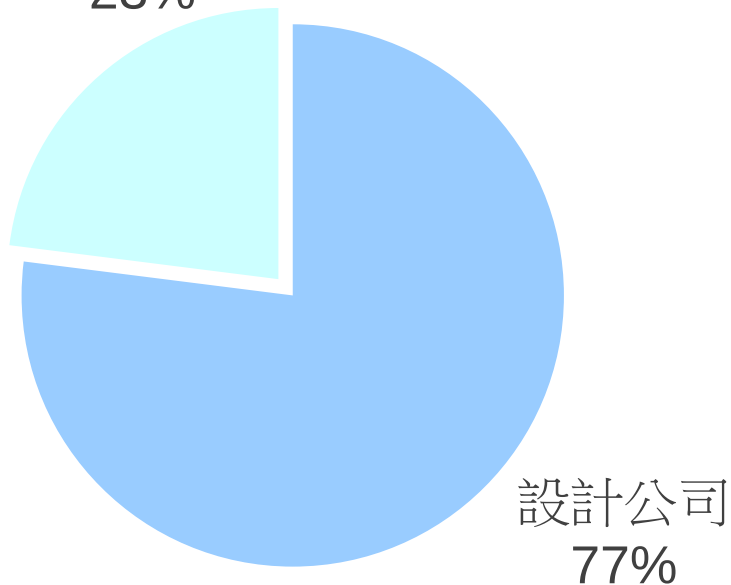
歐洲 9% 日本 7%



晶圓製造整合銷售分析－客戶別

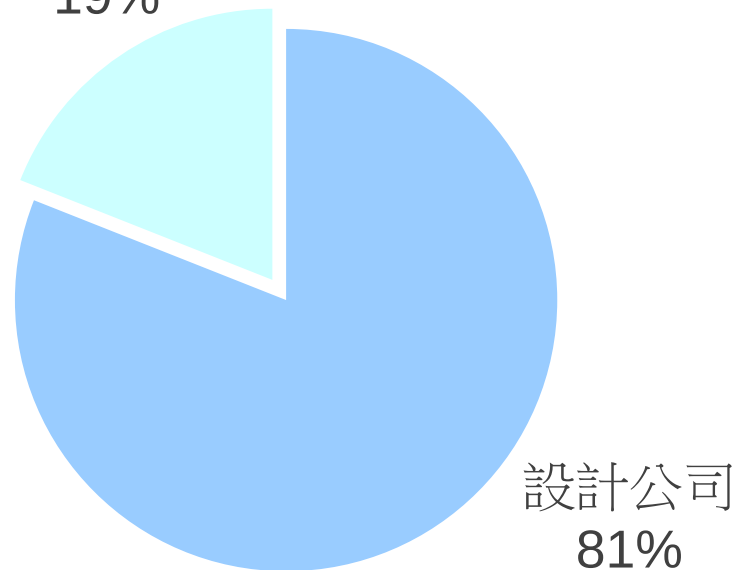
1Q23

整合元件廠
23%



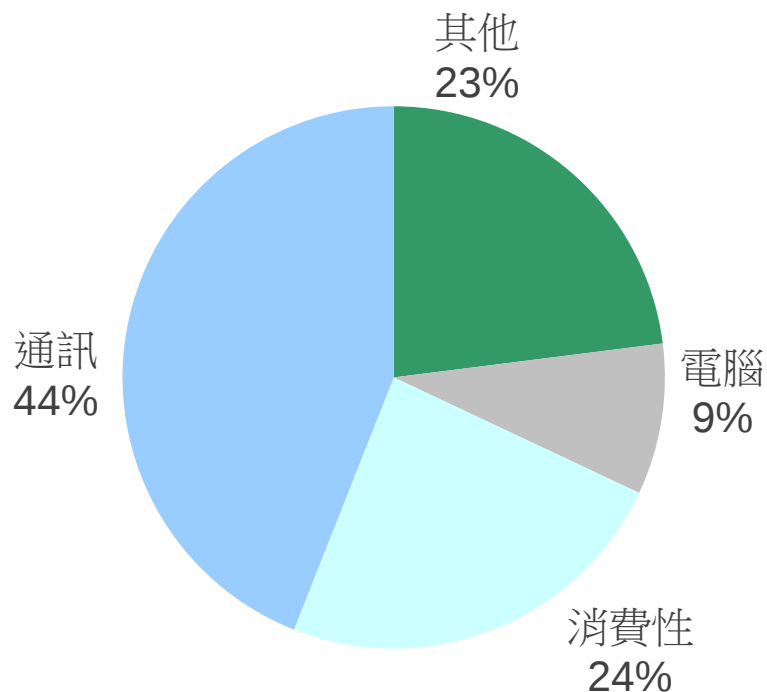
4Q22

整合元件廠
19%

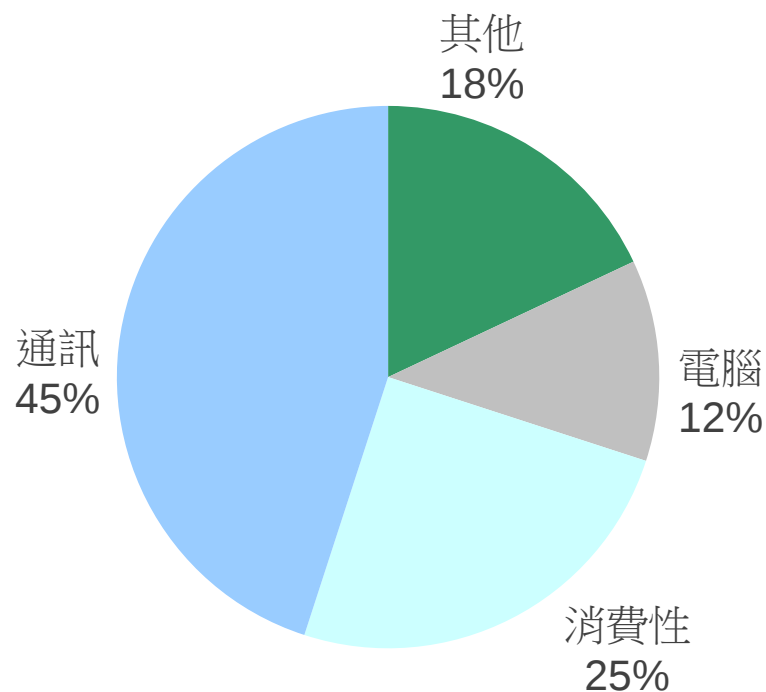


晶圓製造整合銷售分析－產品應用別

1Q23

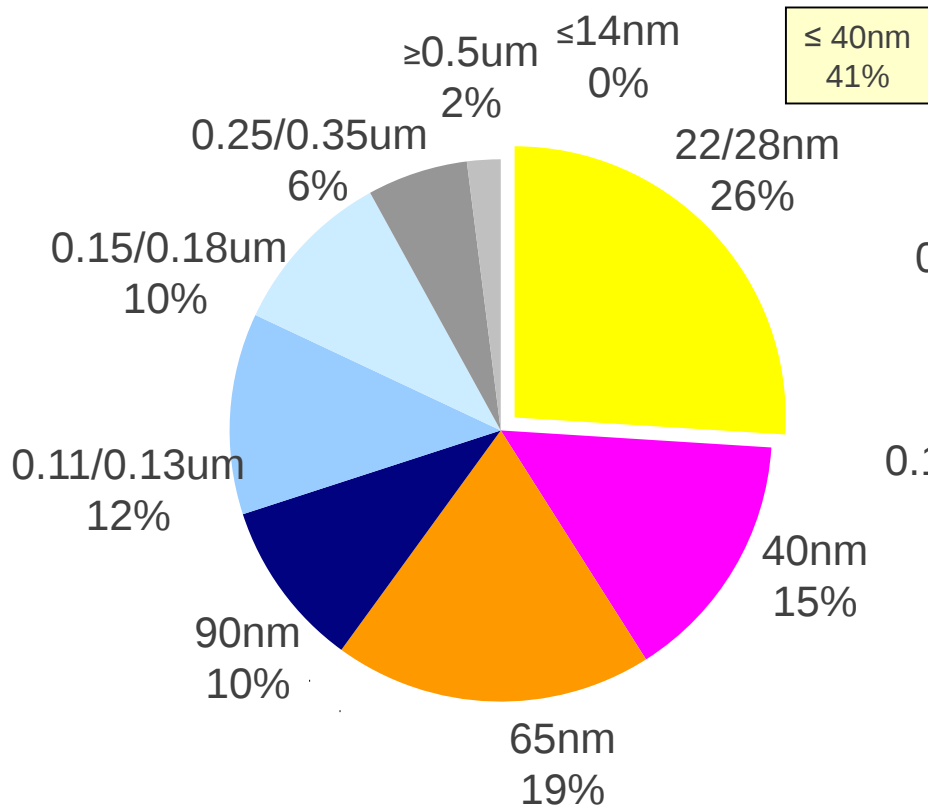


4Q22

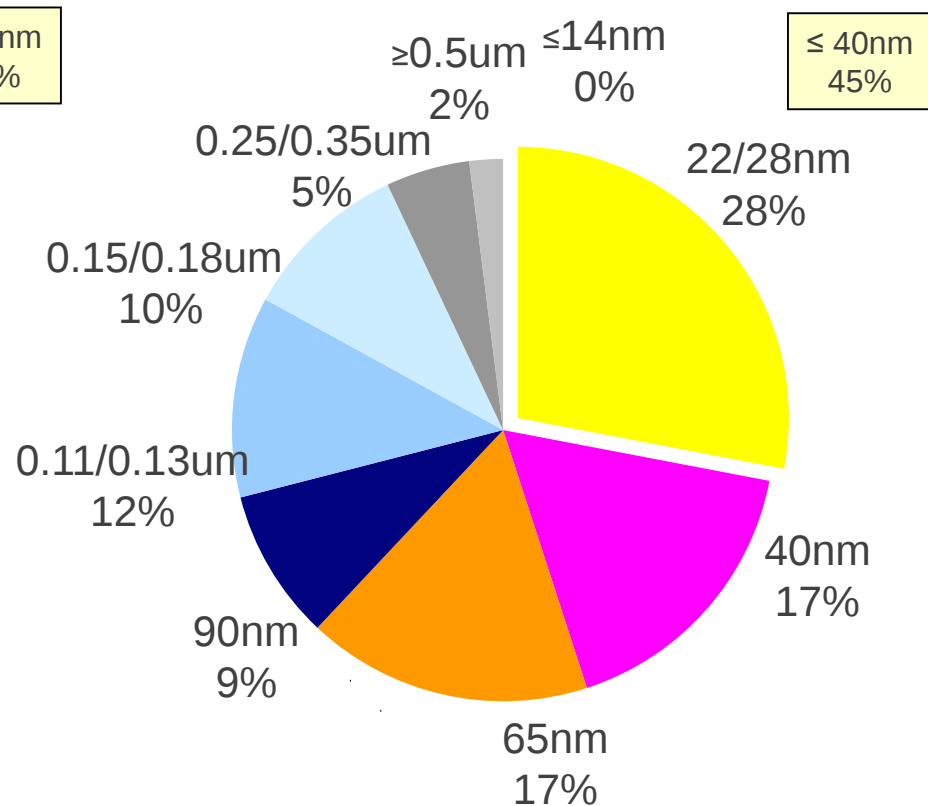


晶圓製造整合銷售分析－製程別

1Q23



4Q22



季產能資訊

單位: 仟片

FAB		111年 第三季	111年 第四季	112年 第一季	112年 第二季
WTK	(6")	85	85	80	82
8A	(8")	192	192	189	207
8C	(8")	115	115	113	120
8D	(8")	103	103	101	109
8E	(8")	118	118	116	122
8F	(8")	138	138	136	145
8S	(8")	111	111	109	112
8N	(8")	242	245	244	248
12A	(12")	301	301	305	321
12i	(12")	164	164	162	164
12X	(12")	80	80	78	80
12M	(12")	110	110	108	110
合計	(8" eq.)	2,539	2,543	2,522	2,626

112年晶圓製造整合資本支出計劃

8"	12"	合計
10%	90%	30 億美元

For more information regarding UMC
www.umc.com

For all inquiries, suggestions, and comments
ir@umc.com